S/N 09/615,922

<u>IN THE UNITED STATES PATENT AND TRADEMARK OFFICE</u>

Applicant:

George K. Korinsky et al.

Examiner: Gregory Thompson

Serial No.:

09/615,922

Group Art Unit: 2835

Filed:

July 13, 2000

Docket: 884.298US1

Title:

METHOD AND APPARATUS FOR DISSIPATING HEAT FROM AN

ELECTRONIC DEVICE

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents Washington, D.C. 20231

Applicant has reviewed the Office Action mailed on <u>July 5, 2002</u>. Please amend the above-identified patent application as follows.

This response is accompanied by a Petition, as well as the appropriate fee, to obtain a three-month extension of the period for responding to the Office action, thereby moving the deadline for response from October 5, 2002 to January 5, 2003, which is a Sunday.

IN THE DRAWINGS

Please substitute originally-filed drawing sheets corresponding to Figure 9 with red-lined drawing sheet corresponding to Figure 9 enclosed herewith. Figure 9 is amended to correct typographical errors. A complete set of formal drawings is also enclosed.

IN THE SPECIFICATION

Please make the paragraph substitutions indicated in the appendix entitled "Clean Version of Amended Specification Paragraphs". The specific changes incorporated in the substitute paragraphs are shown in the following marked-up versions of the original paragraphs.

The paragraph beginning on page 5, line 4 is amended as follows:

The housing 202 is adapted to be closely fitted to a heat sink. The housing 202 has a first end 204 and a second end 206. The first end 204 is adapted to hold [a] an air moving device 203. In one embodiment, the housing 202 attaches to a processor socket. In one embodiment, various cooling attachments can be attached to the first end 204 and the second end 206 of the housing 202 to provide a multitude of thermal solutions for high performance electronic devices.

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